Attorney Docket No.: 0756-2045

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Kenji ITOH et al.

Serial No.: 09/412,510

Filed: October 5, 1999

PROCESS FOR TREATING A For:

SUBSTRATE WITH A PLASMA

(As Amended)

02/09/2001 TGEDAMU1 00000016 09412510

01 FC:102

80.00 OP

AMENDMENT

Art Unit: 1762

Examiner: M. Padgett

CERTIFICATE OF MAILING

hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231. on

Honorable Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated September 1, 2000, please amend the aboveidentified application as follows:

IN THE TITLE:

Please replace the title of the present invention with the following:

-- PROCESS FOR TREATING A SUBSTRATE WITH A PLASMA--.

IN THE SPECIFICATION:

Please delete the first sentence of the specification and insert in its place +This application is a Divisional of U.S. Patent 6,001,431, filed February 21, 1996, which itself is a

Continuation of Application Serial No. 08/173,961, filed December 28, 1993, now abandoned.--

Please amend the specification as follows:

Page 2, line 11, change "field" to --fields--;

line 23, before "advantage" insert --cost--;

line 24, delete "in cost".

Page 4, line 27, before "plane" insert --a--.

NVA169558.1